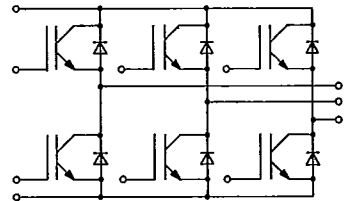
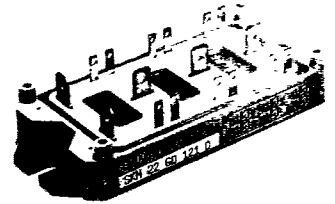


**SEMITRANS® M**  
**IGBT Modules**

**SKM 22 GD 101 D**  
**SKM 22 GD 121 D**

T.39-31



Absolute Maximum Ratings		Values		Units
Symbol	Conditions <sup>1)</sup>	... 101 D	... 121 D	
V <sub>CEs</sub>		1000	1200	V
V <sub>CGR</sub>		1000	1200	V
I <sub>c</sub>	R <sub>GE</sub> = 20 kΩ T <sub>case</sub> = 25/80 °C		22/15	A
I <sub>CM</sub>	T <sub>case</sub> = 25/80 °C		44/30	A
V <sub>GES</sub>			± 20	V
P <sub>tot</sub>	per IGBT, T <sub>case</sub> = 25 °C		150	W
T <sub>j</sub> , T <sub>stg</sub>			-55 ... +150	°C
Visol	AC, 1 min		2 500	V
humidity	DIN 40 040		Class F	
climate	DIN IEC 68 T.1		55/150/56	
Inverse Diode				
I <sub>F</sub> = - I <sub>c</sub>			22	A
I <sub>FM</sub> = - I <sub>CM</sub>			44	A

Characteristics		min. typ. max.			Units
Symbol	Conditions <sup>1)</sup>				
V <sub>(BR)CES</sub>	V <sub>GE</sub> = 0, I <sub>c</sub> = 0,5 mA	≥ V <sub>CEs</sub>	-	-	V
V <sub>GE(th)</sub>	V <sub>GE</sub> = V <sub>CE</sub> , I <sub>c</sub> = 1 mA	4,5	5,5	6,5	V
I <sub>CEs</sub>	V <sub>GE</sub> = 0 } T <sub>j</sub> = 25 °C V <sub>CE</sub> = V <sub>CEs</sub> } T <sub>j</sub> = 125 °C	-	-	0,5	mA
I <sub>GES</sub>	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0	-	-	100	nA
V <sub>CEsat</sub>	V <sub>GE</sub> = 15 V } T <sub>j</sub> = 25 °C I <sub>c</sub> = 22 A } T <sub>j</sub> = 150 °C	-	3,5	4	V
g <sub>fs</sub>	V <sub>CE</sub> = 20 V, I <sub>c</sub> = 22 A	5,5	9	-	S
C <sub>CHC</sub>	per IGBT	-	-	60	pF
C <sub>ies</sub>	V <sub>GE</sub> = 0	-	2	-	nF
C <sub>oes</sub>	V <sub>CE</sub> = 25 V	-	160	-	pF
C <sub>res</sub>	f = 1 MHz	-	65	-	pF
L <sub>CE</sub>		-	-	20	nH
t <sub>d(on)</sub>	V <sub>CC</sub> = 600 V	-	40 <sup>3)</sup>	-	ns
t <sub>r</sub>	V <sub>GE</sub> = 15 V	-	100 <sup>3)</sup>	-	ns
t <sub>d(off)</sub>	I <sub>c</sub> = 22 A	-	150 <sup>3)</sup> /150 <sup>4)</sup>	-	ns
t <sub>f</sub>	R <sub>Gon</sub> = R <sub>Goff</sub> = 3,3 Ω	-	500 <sup>3)</sup> /100 <sup>4)</sup>	-	ns
W <sub>off12</sub> <sup>5)</sup>	T <sub>j</sub> = 125 °C	-	1,3 <sup>4)</sup>	-	mWs
W <sub>off23</sub> <sup>5)</sup>		-	0,7 <sup>4)</sup>	-	mWs
Inverse Diode SKM 22 GD 101 D					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 22 A, V <sub>GE</sub> = 0; (T <sub>j</sub> = 125 °C)	-	2,2 (1,8)	2,7	V
t <sub>rr</sub>	T <sub>j</sub> = 25 °C <sup>2)</sup>	-	-	-	ns
	T <sub>j</sub> = 125 °C <sup>2)</sup>	-	100	-	ns
Q <sub>rr</sub>	T <sub>j</sub> = 25/125 °C <sup>2)</sup>	-	1/4	-	μC
f <sub>s</sub>	f <sub>s</sub> = t <sub>f</sub> / (t <sub>rr</sub> - t <sub>f</sub> )	-	1 <sup>2)</sup>	-	
Inverse Diode SKM 22 GD 121 D					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 22 A, V <sub>GE</sub> = 0; (T <sub>j</sub> = 125 °C)	-	2,7 (2,2)	3,2	V
t <sub>rr</sub>	T <sub>j</sub> = 25 °C <sup>2)</sup>	-	-	-	ns
	T <sub>j</sub> = 125 °C <sup>2)</sup>	-	120	-	ns
Q <sub>rr</sub>	T <sub>j</sub> = 25/125 °C <sup>2)</sup>	-	1,1/4,5	-	μC
f <sub>s</sub>	f <sub>s</sub> = t <sub>f</sub> / (t <sub>rr</sub> - t <sub>f</sub> )	-	1 <sup>2)</sup>	-	
Thermal Characteristics					
R <sub>thjc</sub>	per IGBT	-	-	0,8	°C/W
R <sub>thjc</sub>	per diode	-	-	1,3	°C/W
R <sub>thch</sub>	per module	-	-	0,05	°C/W

Cases and mechanical data see page B 6 – 78

1) T<sub>case</sub> = 25 °C, unless otherwise specified  
 2) I<sub>F</sub> = - I<sub>c</sub>, V<sub>R</sub> = 600 V, - di<sub>F</sub>/dt = 800 A/μs, V<sub>GE</sub> = 0  
 3) resistive load  
 4) inductive load  
 5) see fig. 21; R<sub>Goff</sub> = 19 Ω

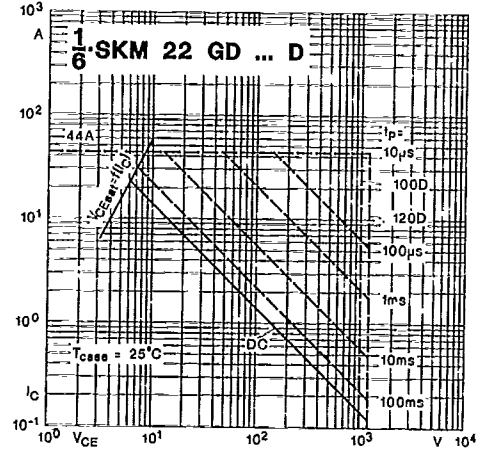
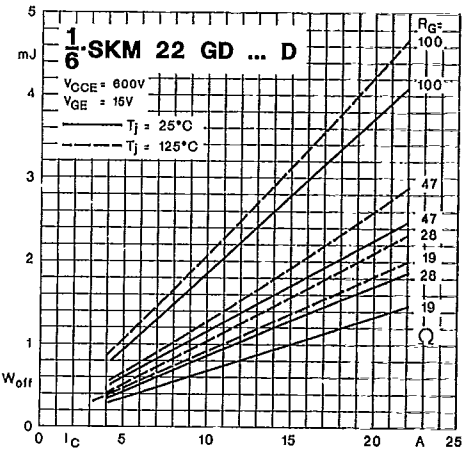
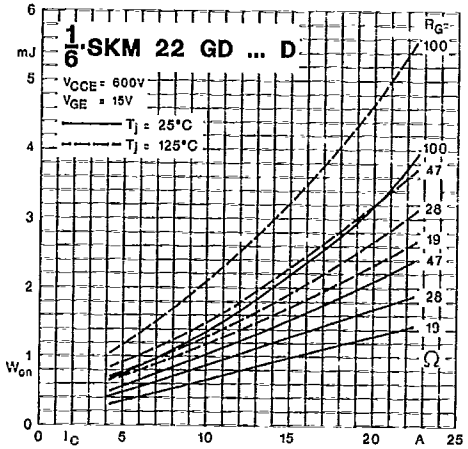
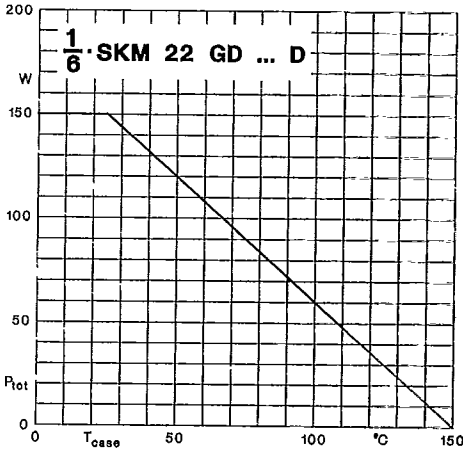
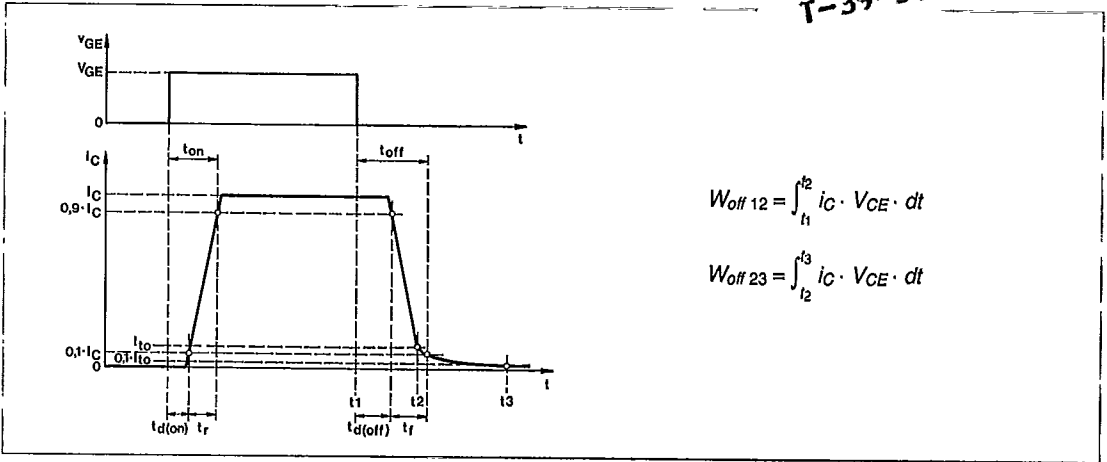
**Features**

- MOS input (voltage controlled)
- N channel
- Low saturation voltage
- Very low tail current
- Low temperature sensitivity
- Breakdown proof
- High short circuit capability
- No latch-up
- Fast inverse diodes
- Isolated copper baseplate
- Large clearances and creepage distances
- UL recognized, file no. E 63 532

**Typical Applications**

- DC servo and robot drives
- Self-commutated inverters
- AC motor speed control
- Uninterruptible power supplies
- General power switching applications
- Pulse frequencies above 15 kHz

T-39-31



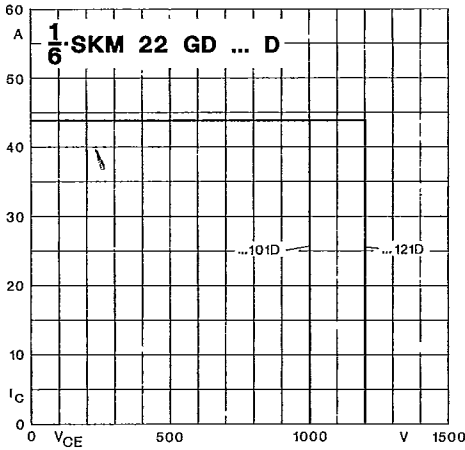


Fig. 26 Turn-off safe operating area

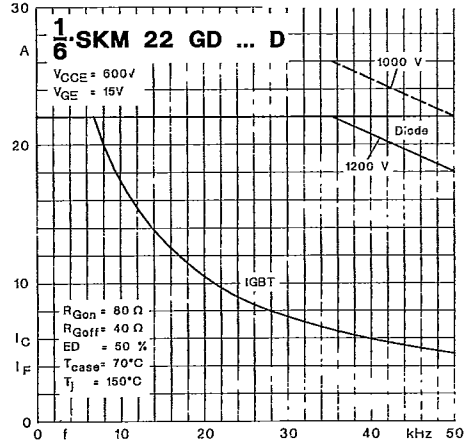


Fig. 27 Rated current vs. pulse frequency

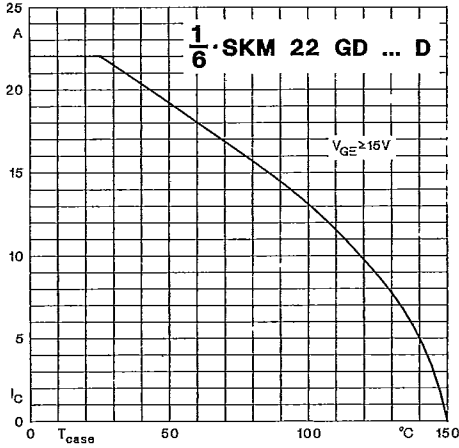


Fig. 28 Rated current vs. temperature

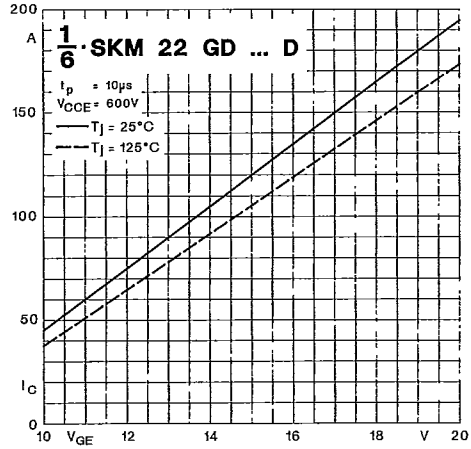


Fig. 29 Short-circuit current vs. turn-on gate voltage

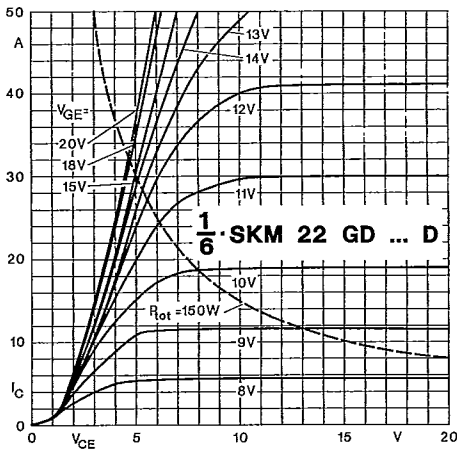


Fig. 30 Output characteristic

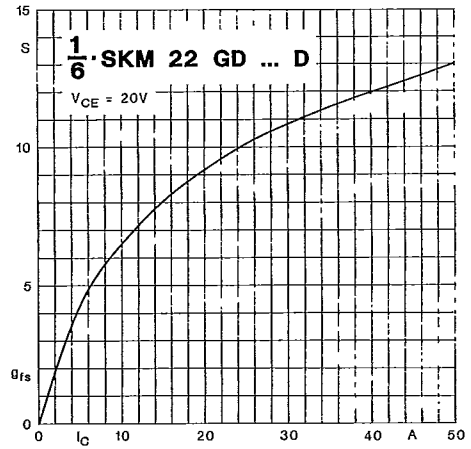


Fig. 31 Forward transconductance

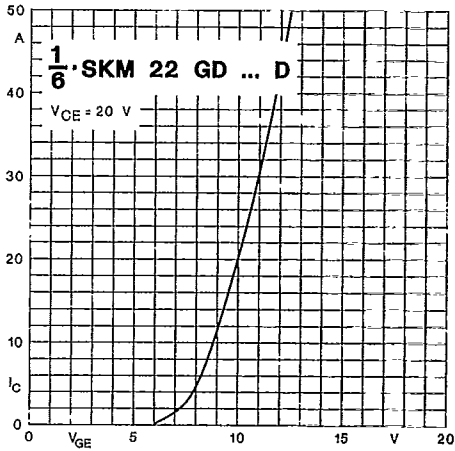


Fig. 32 Transfer characteristic

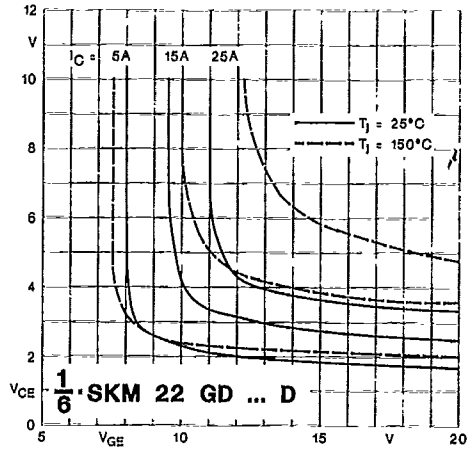


Fig. 33 Saturation characteristics

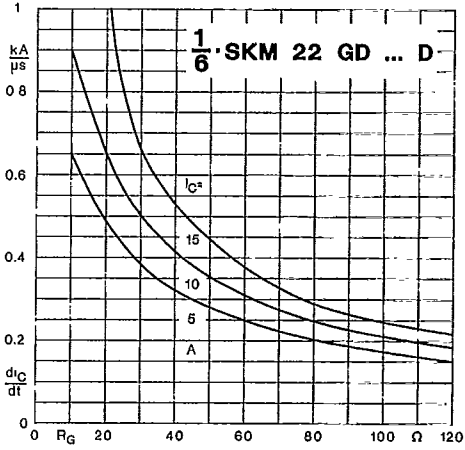


Fig. 34 Rate of rise of collector current

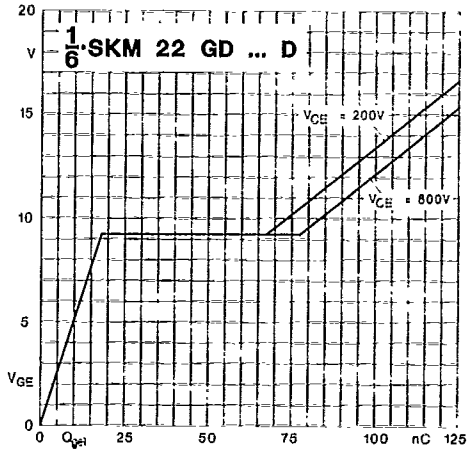


Fig. 35 Gate charge characteristic

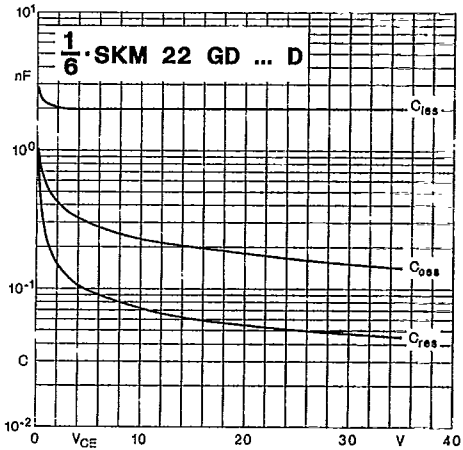


Fig. 36 Capacitances vs. collector-emitter voltage

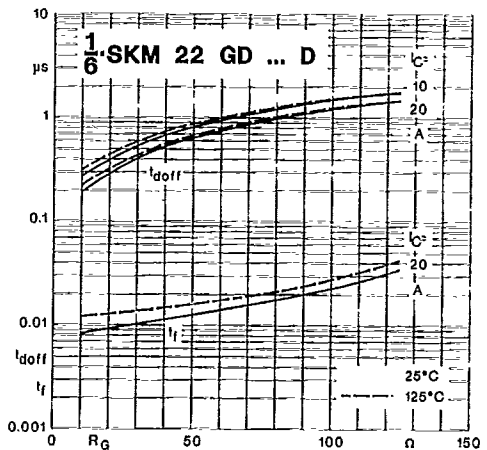


Fig. 37 Switching times vs. gate resistor

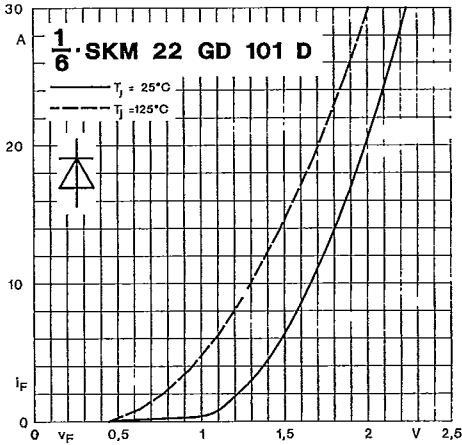


Fig. 38 a Diode forward characteristic

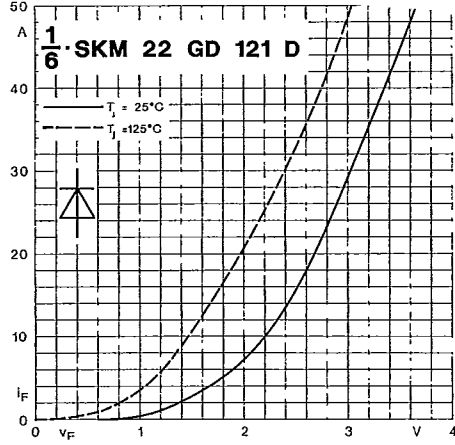


Fig. 38 b Diode forward characteristic

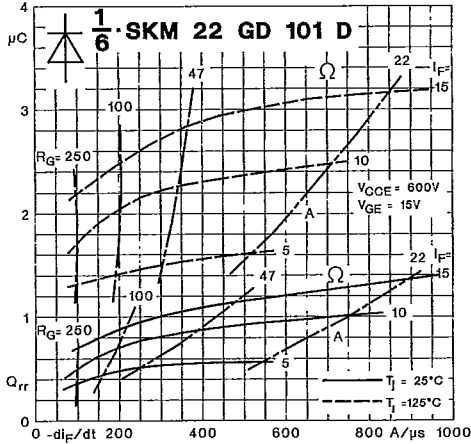


Fig. 39 a Diode recovered charge

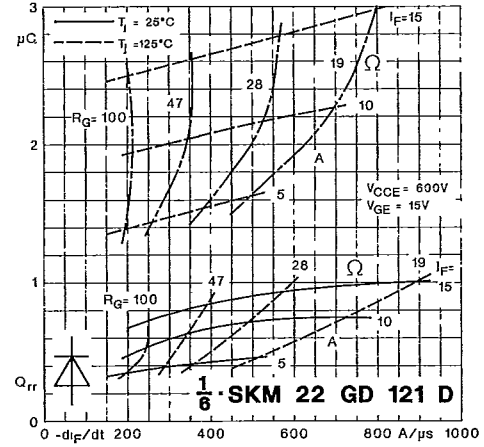


Fig. 39 b Diode recovered charge

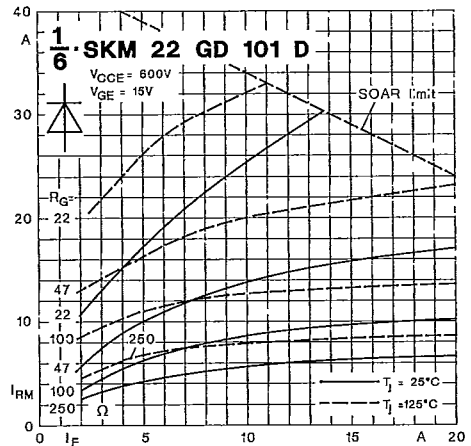


Fig. 40 a Diode peak reverse recovery current ( $I_F$ )

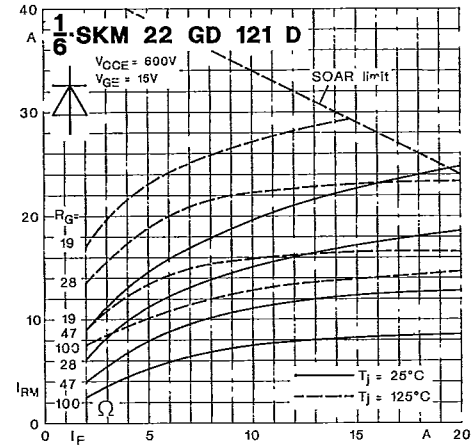


Fig. 40 b Diode peak reverse recovery current ( $I_F$ )

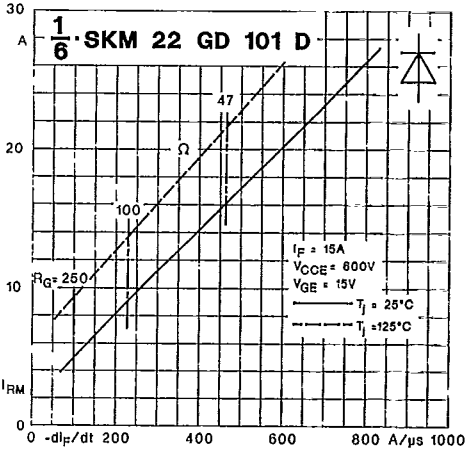


Fig. 41 a Diode peak reverse recovery current (-diF/dt)

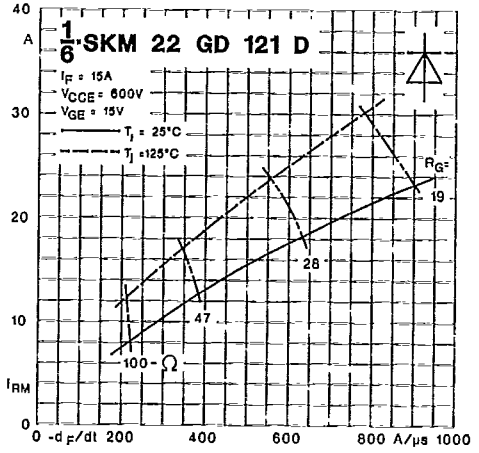


Fig. 41 b Diode peak reverse recovery current (-diF/dt)

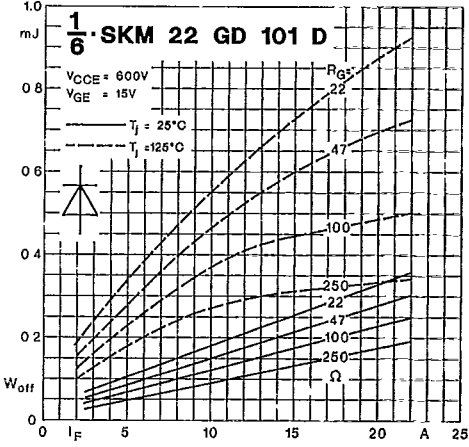


Fig. 42 a Diode turn-off energy dissipation per pulse

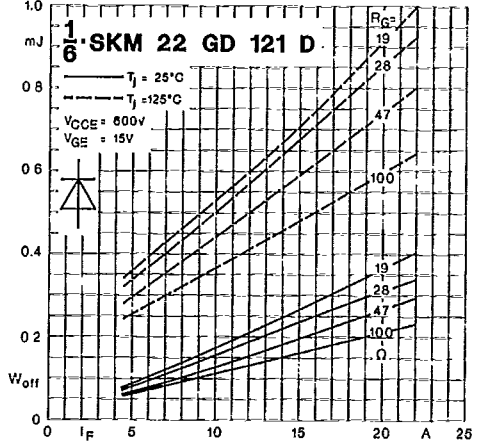


Fig. 42 b Diode turn-off energy dissipation per pulse

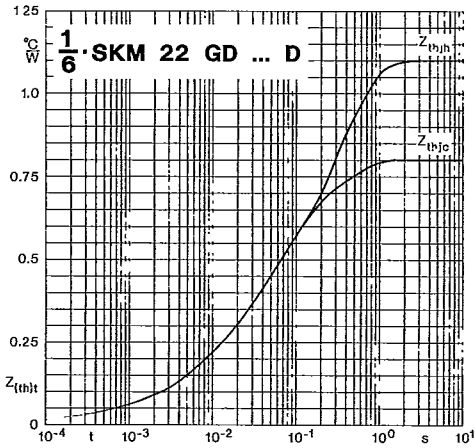


Fig. 51 Transient thermal impedance

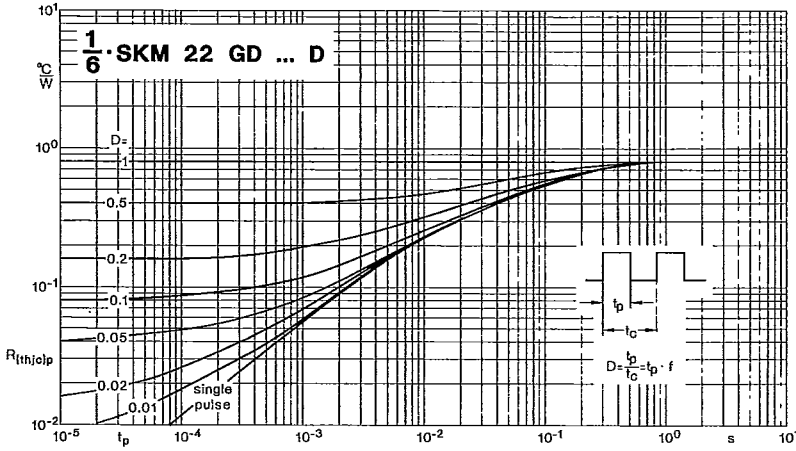


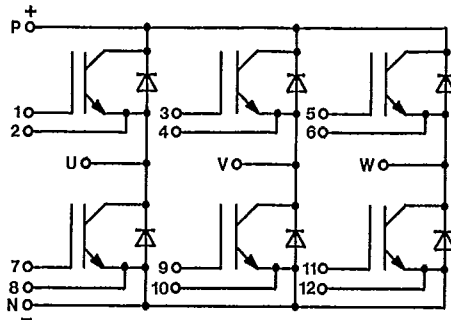
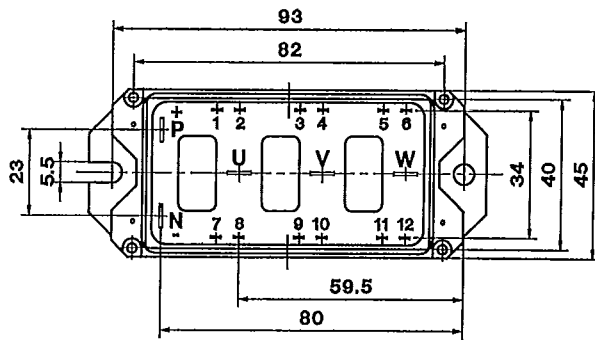
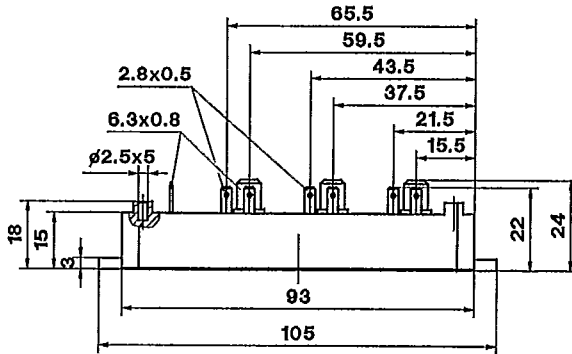
Fig. 52 Thermal impedance under pulse conditions

SKM 22 GD 101 D

SKM 22 GD 121 D

Case D 28

UL recognized, file no. E 63 532



Dimensions in mm

**Mechanical Data**

Symbol	Conditions	Values			Units
		min.	typ.	max.	
M <sub>1</sub>	to heatsink, SI Units	4	—	6	Nm
	to heatsink, US Units	35	—	53	lb.in.
a		—	—	5x9,81	m/s <sup>2</sup>
w		—	—	190	g

This is an electrostatic discharge sensitive device (ESDS). Please observe the international standard IEC 747-1, Chapter IX.